

MICRON (MIniaturised aCceleRatOrs Network)

«L'esperimento MICRON propone lo sviluppo di **strutture elettromagnetiche ad alto gradiente accelerante** sia di tipo **dielettrico** che di tipo **metallico**.

Più in dettaglio si parla di strutture dielettriche alimentate da laser infrarosso con gradienti al di sopra di **500 MV/m** e strutture metalliche da banda Ka (35 GHz) a banda W (100 GHz) con gradienti superiori a **100 MV/m**.

L'obiettivo finale per entrambe le strutture è la **costruzione e il test a freddo.**»
[Verbale Riunione dei Ref.]

Motivations

High accelerating gradients enable compact/miniaturized particle accelerators

MAIN GOAL of the PROPOSAL: Miniaturization of Accelerating Structures

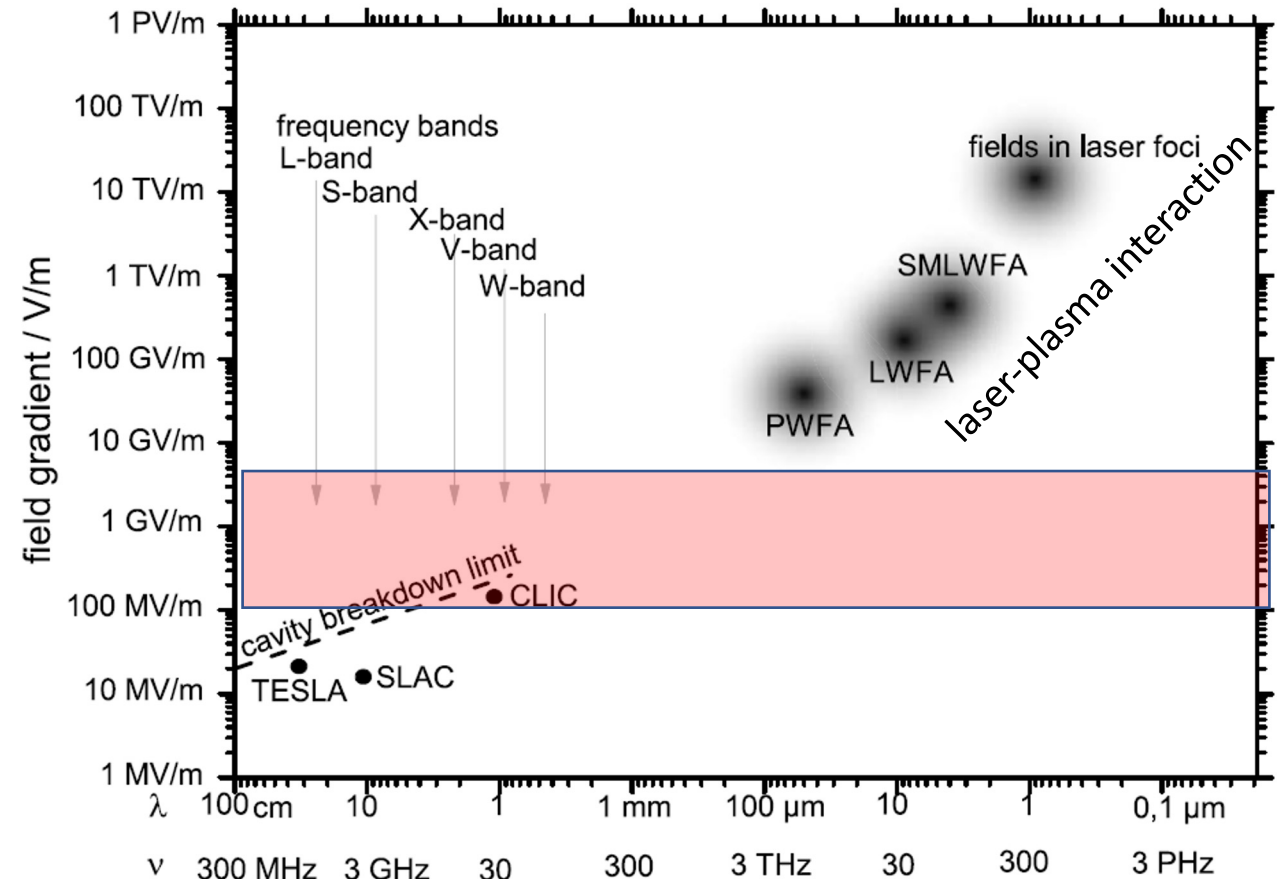
TARGET OF THE PROSAL

Accelerating Gradient: ~ 100 MV/m - 2 GV/m

1) Metallic Structure from Ka to W-band
(35-200 GHz, mm-wavelength)

2) Dielectric Laser Accelerator (DLA)
structures operating at optical
wavelengths (~ 1- 5 μm)

schematic overview of the accelerating gradient for different types of accelerators



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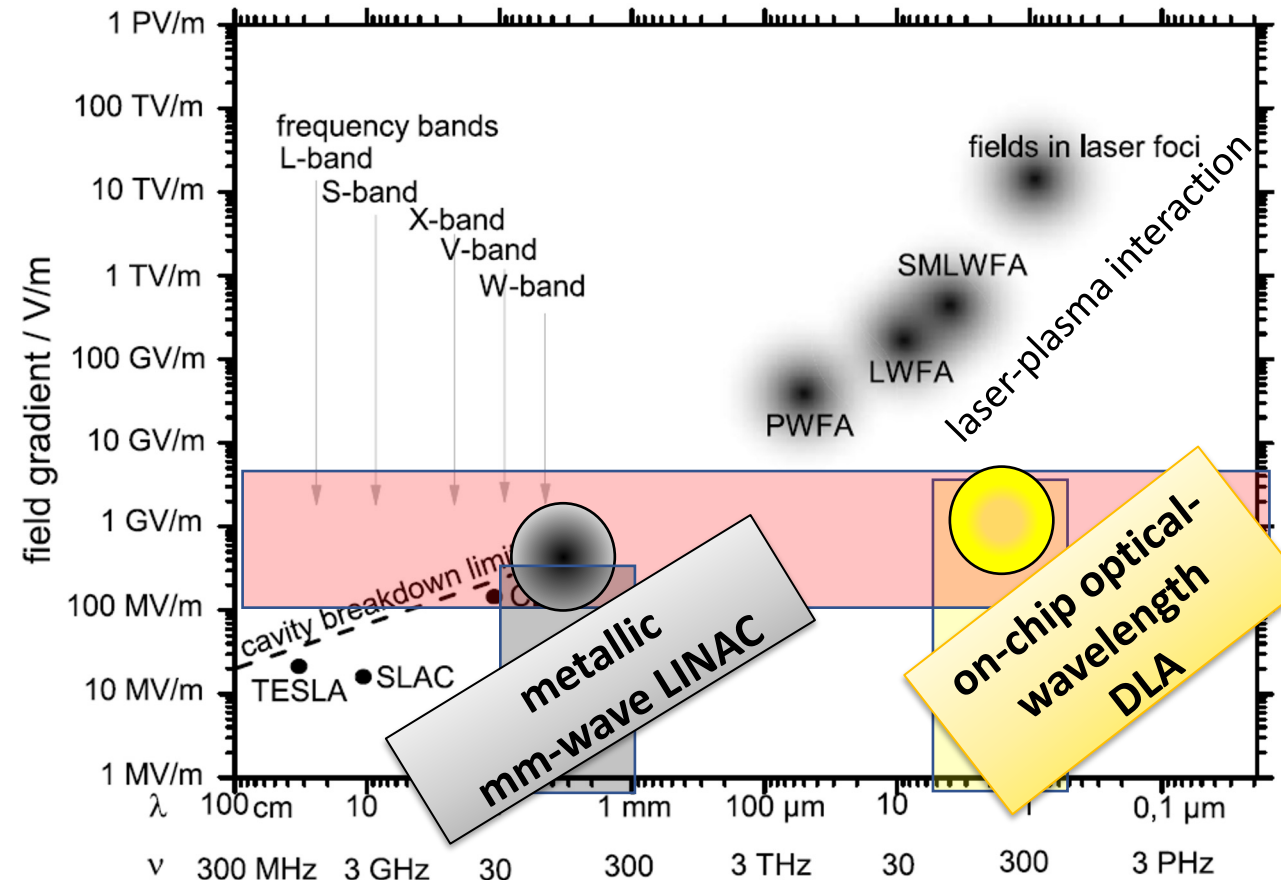
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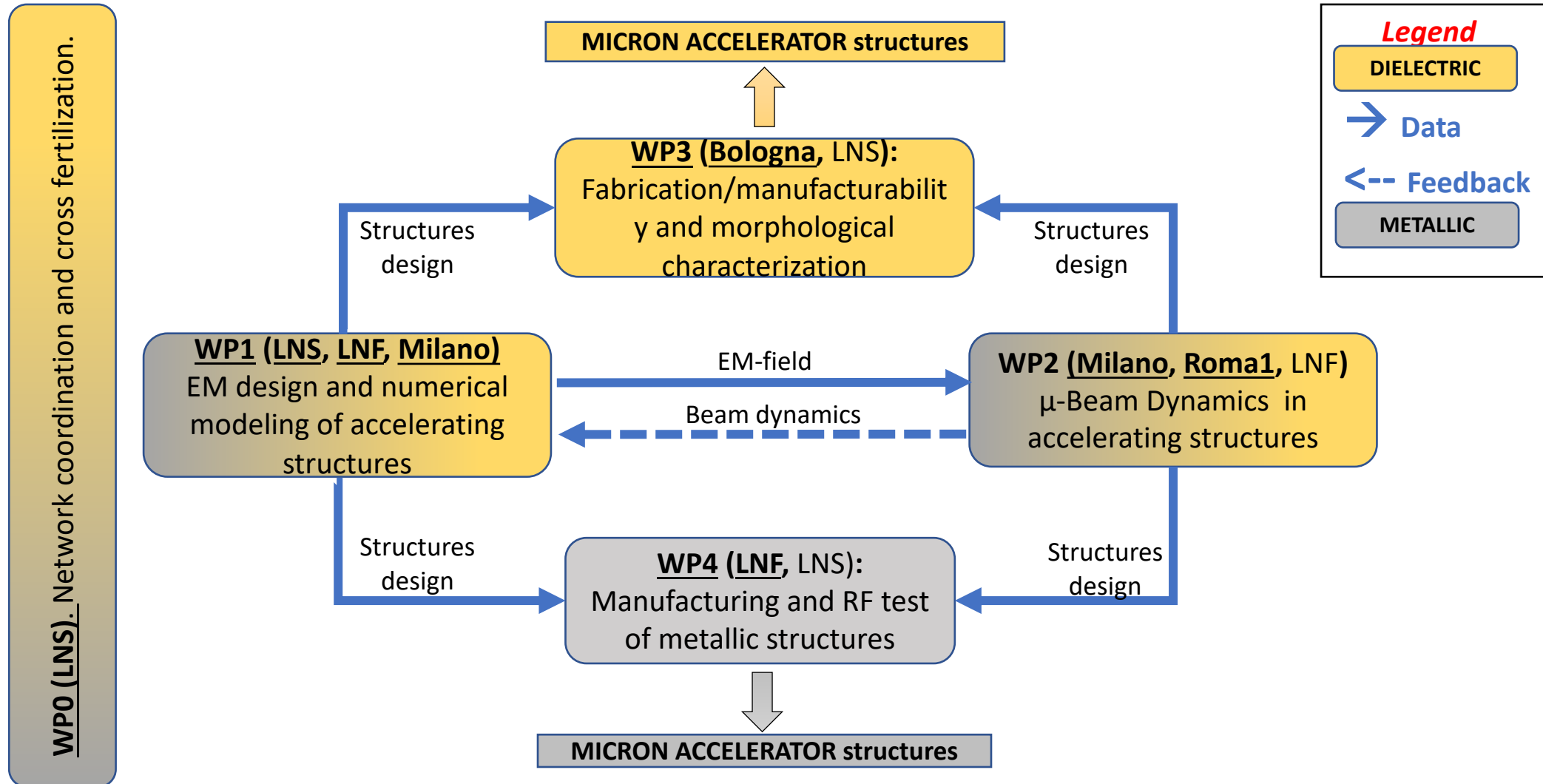
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schematic overview of the accelerating gradient for different types of accelerators



Struttura del progetto



Planning

Scala dei tempi (piano di svolgimento)

PERIODO

ATTIVITA' PREVISTA

1-15

RF design of metallic Ka and W-band cells and mode launcher

1-24

Beam dynamics (GPT) and wakefield in metallic structures (CST, ASTRA)

1-27

Electromagnetic design of optical low- and high- β dielectric structures

1-36

Networking, Management, Dissemination

22-33

RF cold test of metallic prototype

25-36

Fabrication and morphological characterization of dielectric structures

4-24

Welding/Fabricability, Fabrication, Optimization of metallic prototype

4-30

Beam dynamics in dielectric structures (ASTRA)

4-30

Manufacturability of dielectric structures

Legend

DIELECTRIC

METALLIC

WP3: Manufacturing/manufacturability

INFN-BOLOGNA [33.5 k€], LNS

- 2 k€ (resist, developer, materia)
 - 1 k€ (missioni)
- + Anticipo Budget 2021 30.5 k€

WP1 : EM Design

LNS [7 k€], LNF

- 6 k€ (licenza software)
- 1 k€ (missioni)

1st year

BUDGET per unit

WP2: BD, Wakefield

INFN-MI [7 k€]

- 6 k€ (Workstation)
- 1 k€ (missioni)

INFN-ROMA1 [1 k€]

1 k€+ 2 k€ SJ (missioni)

WP4: Manufacturing and test

LNF [23 k€], LNS

- 19 k€ (fabbricazioni)
- 3 k€ (workstation)
- 1 k€ (missioni)

MILESTONES 2022 (1st YEAR)

DIELECTRIC

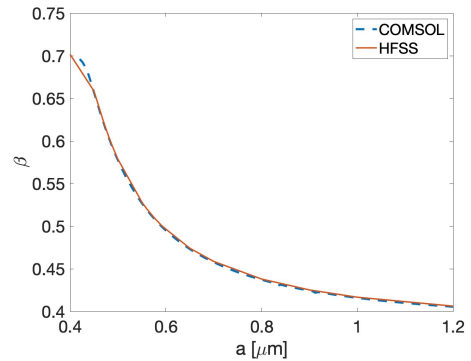
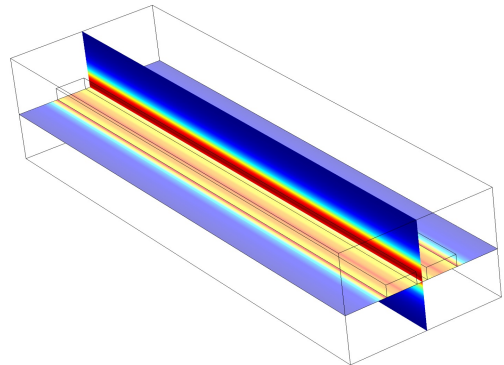
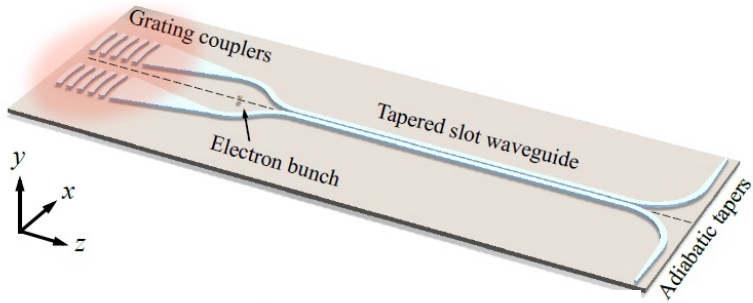
METALLIC

- **1.** Evaluation of Figure of Merits on the numerical model
($R_{sh} > 150 \text{ M}\Omega/\text{m}$, $Q > 5000$)
($Z_c > 500 \Omega$, $G > 0.5 \text{ GV/m}$)
- **2.** Repeatable process for polymeric master fabrication
(Adhesion, Consistency 10%, Seamless)
FESEM Characterization
- **3.** Manufacturability test
(tol < $\pm 3 \mu\text{m}$, $R_a < \pm 50 \text{ nm}$)

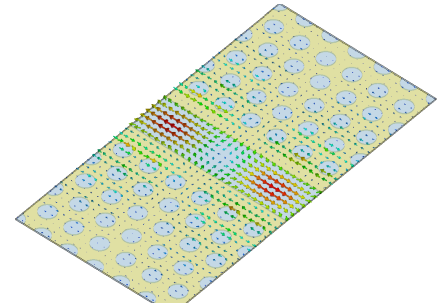
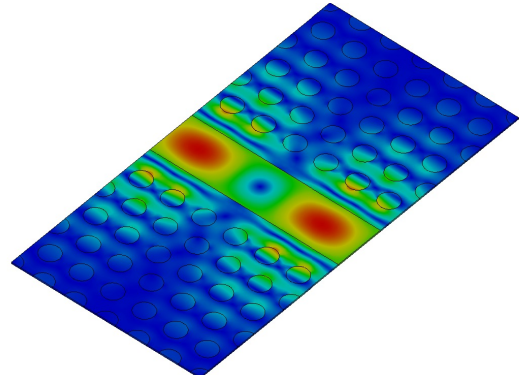
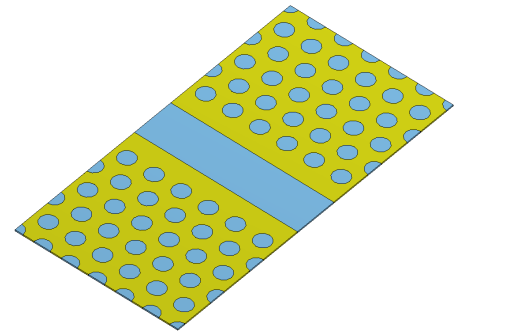
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1. Evaluation of Figure of Merits on the numerical model

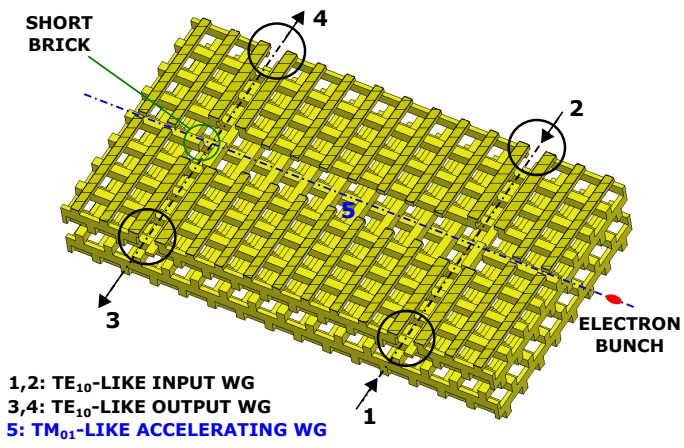
Slotted waveguide @ 5 μm
[0.4 < β < 0.75, Zc=1.5 kΩ]



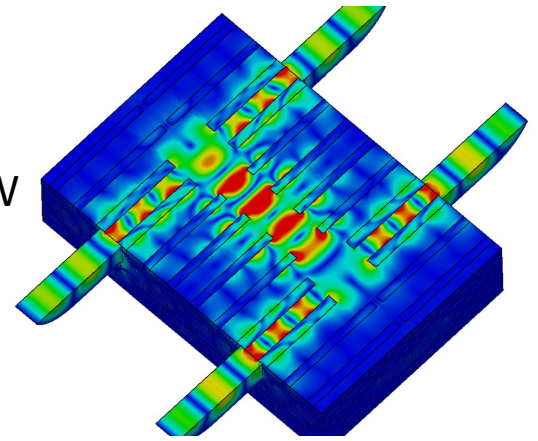
2D photonic crystal waveguide
[0.75 < β < 1]



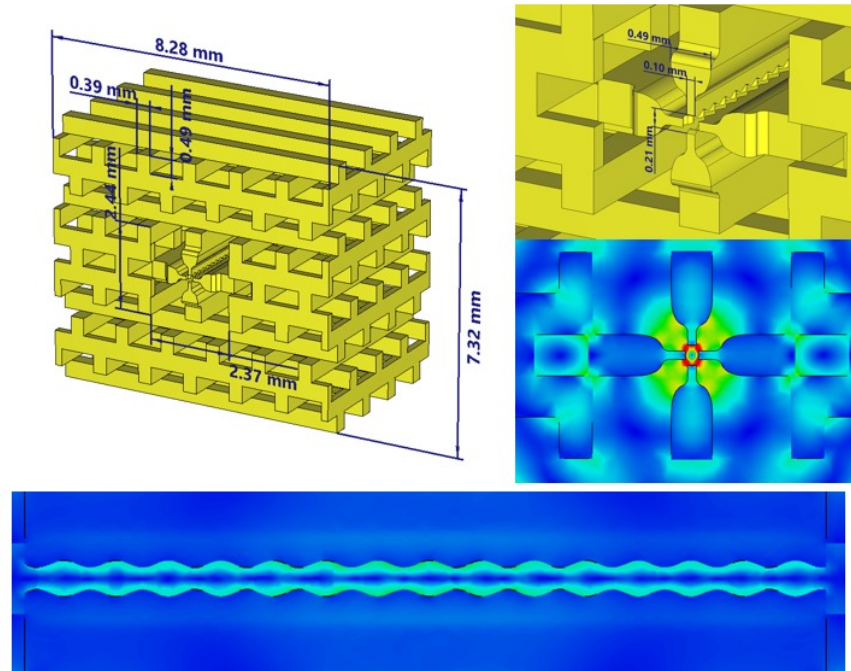
Woodpile @ 5 μm
[β = 1, Zc = 11.4 kΩ]



~ 1 GV/m
@ P_inj=1 kW



Dielectric Photonic Crystal woodpile-based RFQ [from β 0.05 to 0.2]



Brevetto INFN

Metodo per progettare una struttura accelerante dielettrica che supporta un modo TE₂₁₀-like perturbato (Ita. Patent pending n. 102021000021158)

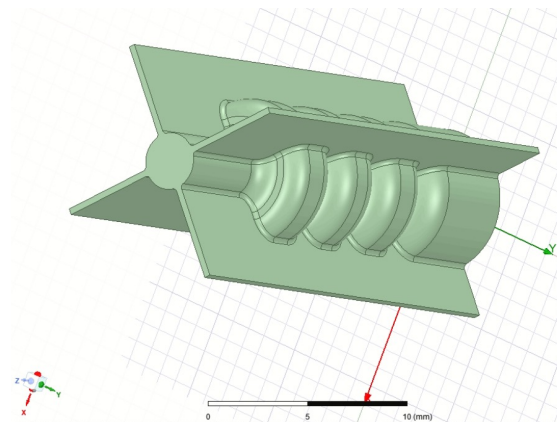
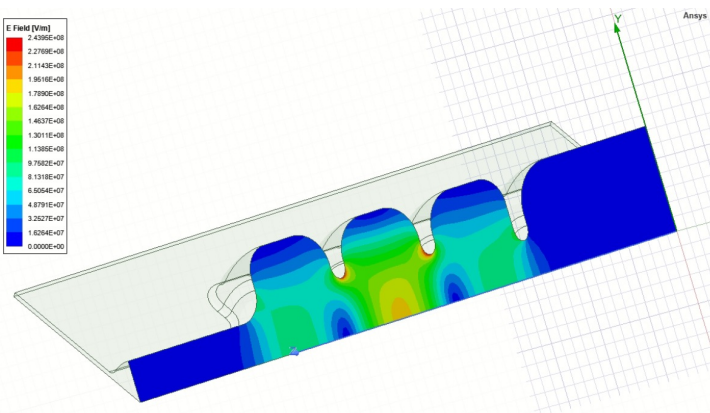
By: G. S. Mauro, G. Torrisi, D. Mascali, G. Sorbello, S. Gammino (INFN-LNS),
G. Della Valle (PoliMi)

ongoing

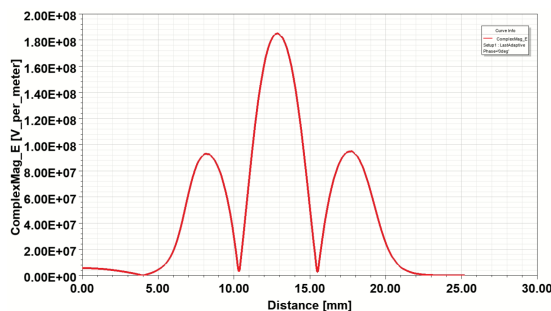
- Beam Dynamics setup...towards An “Adiabatic Phase-Matching Accelerator [1]
- 2D PhC waveguide needs third-dimension confinement

Main RF Parameters

Cavity Design and Prototyping
– Multiple parts open structures



Resonant Modes	Closed structure	4 quadrants
0 mode frequency (GHz)	33.897	33.838
Pi/2 mode frequency (GHz)	34.603	34.580
Pi mode frequency (GHz) Operating mode	35.982	35.982
0 mode Quality factor	5,980	5,883
Pi/2 mode Quality factor	5,806	5,711
Pi mode Quality factor	5,978	5,877
Operating mode (pi) Longitudinal Shunt Impedance (MΩ/m)	240	235



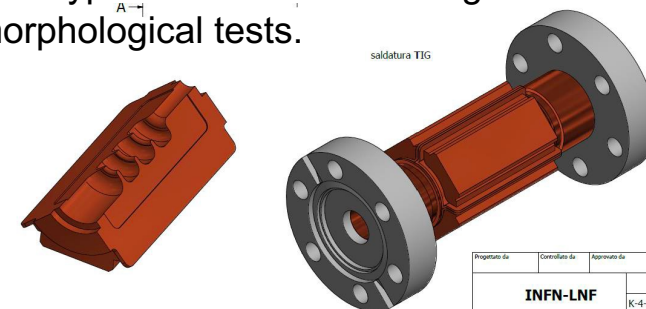
Quadrants vs. Closed structure

- Similar longitudinal shunt impedances;
- Higher lower-modes separation;
- Higher vacuum pumping capacity through slots;
- The quality factor decreases by only 2%.

TIG welding on the outer slots → avoiding high temperature brazing and/or diffusion bonding processes (the typical assembly methods widely used to manufacture ultrahigh vacuum accelerating devices) which - occurring at about 800–1000 °C - significantly change the cavity mechanical properties.

Ka- band cavity Prototyping

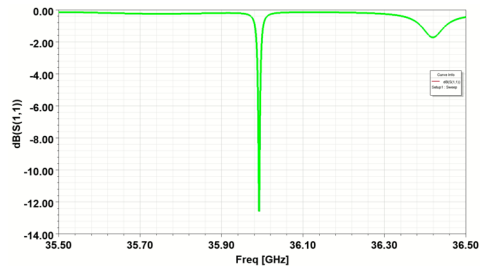
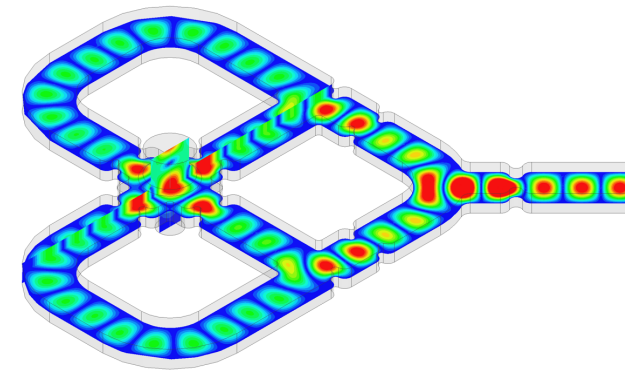
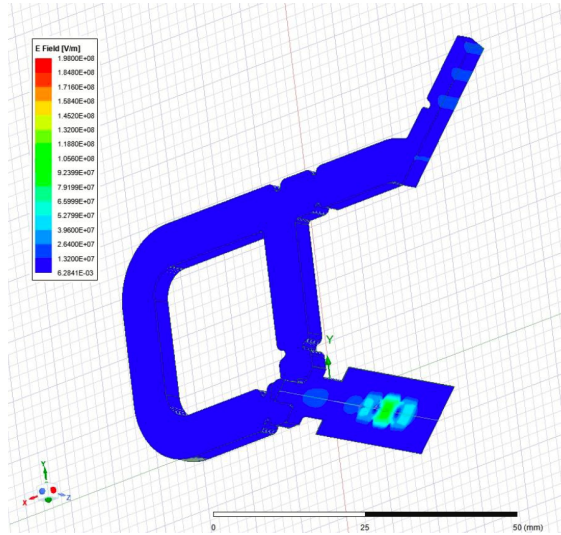
Drawing of the 4-quadrants structure prototype for TIG welding and morphological tests.



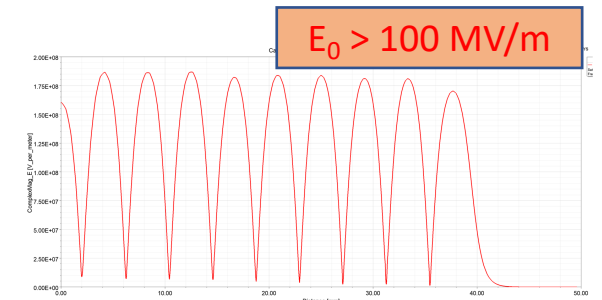
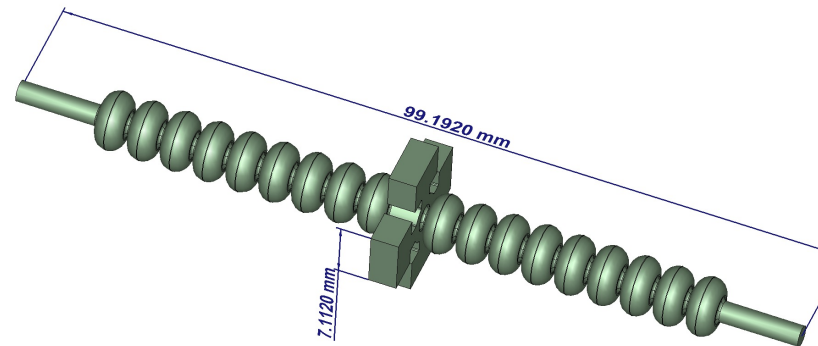
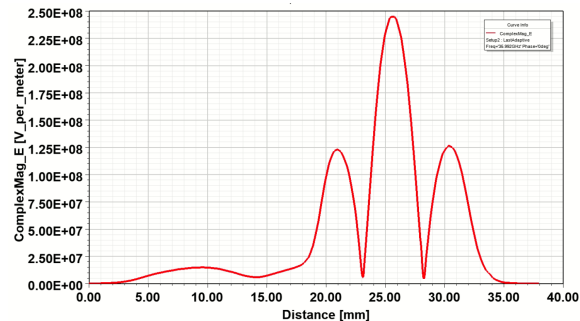
The electric field in the middle cell is two times higher in the middle cell in order to localize and analyze the RF breakdown events.

Ka-band Mode launcher

- Design numerico e caratterizzazione sperimentale di **lanciatori-convertitori di modo** a simmetria quadrupolare.



- Design numerico di **cavità acceleranti per elettroni** ad elevato gradiente, operanti in banda Ka.



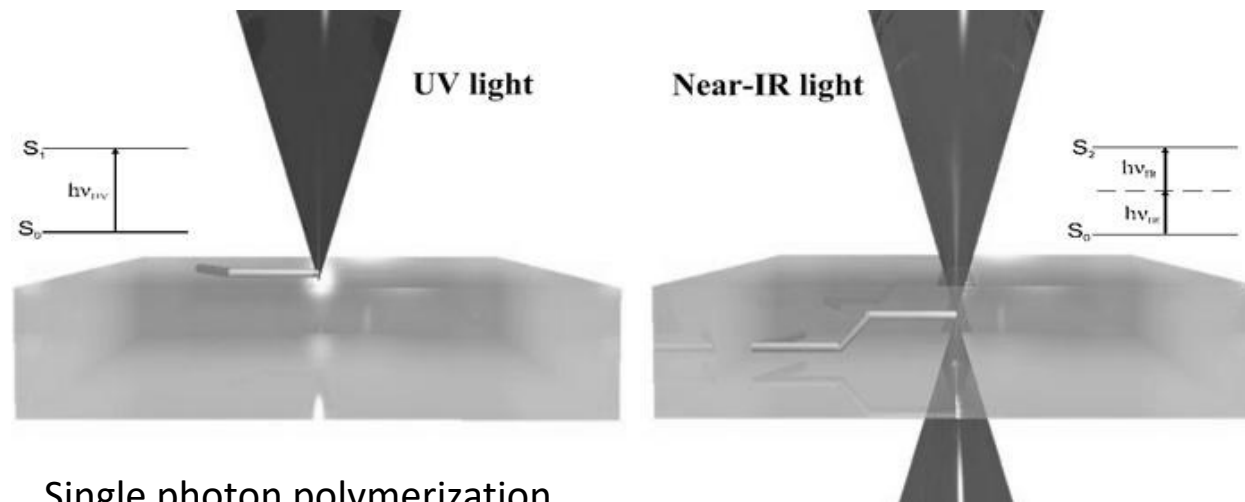
- **2.** Repeatable process for polymeric master fabrication
(Adhesion, Consistency 10%, Seamless)
FESEM Characterization

3D printing at the micro- / nano- scale

Two photon polymerization

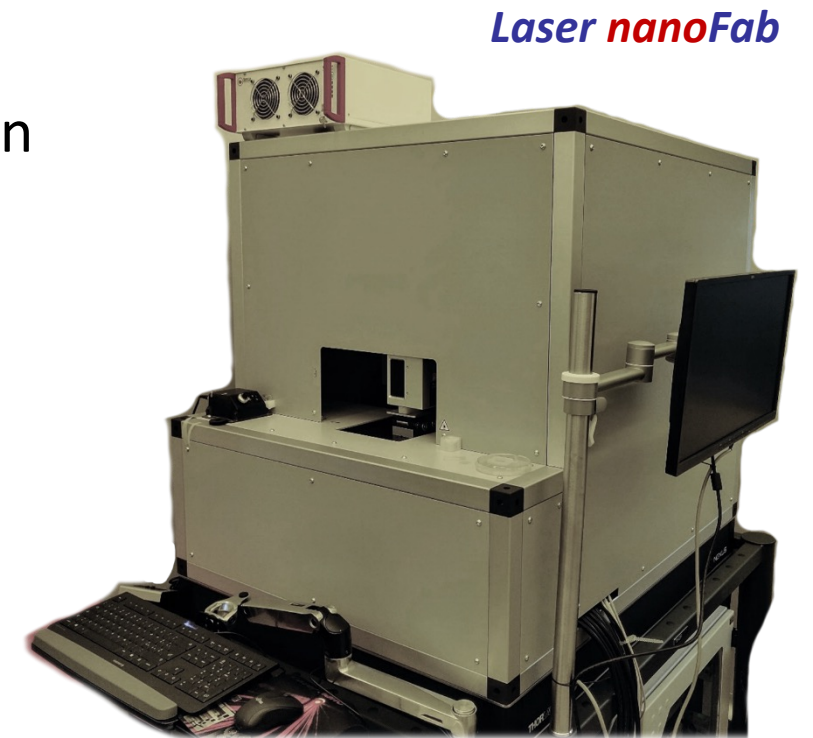
Femtosecond pulsed laser to induce resist polymerization

100x objective



Single photon polymerization
(standard): lower resolution,
surface polymerization

Two photon polymerization: higher
resolution, polymerization inside
volume



M4D System by Laser nanoFab
TPP setup

Anticipo Budget 2021 30 k€



K850 critical point dryer (CPD) from Quorum

- represents a key instrument for the fabrication of dielectric waveguides fabricated at micro/nanometric
- By using CPD, the evaporation step is finely controlled, allowing the replacing of solvent with liquid CO₂, and then CO₂ is removed going beyond its critical point.
- liquid CO₂ changes to vapour without change of density and therefore without surface tension effects which could damage the structures.

CVD / PECVD deposition of Si

AIM: obtain the designed Dielectric PC structure starting from the TPP printed structure



Fabrication of the Si woodpile micrometric structure by covering the polymeric structure obtained by TPP with Si deposited by CVD techniques as

- PECVD (a-Si:H)
- LPCVD (a-Si:H or polySi)

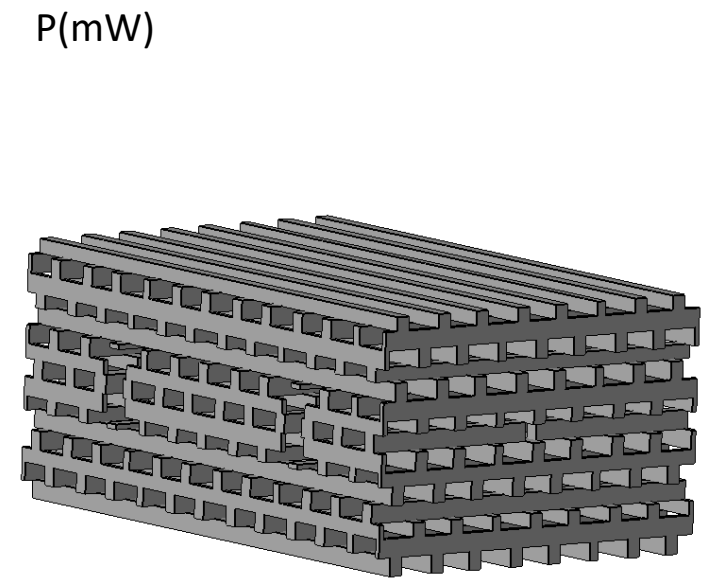
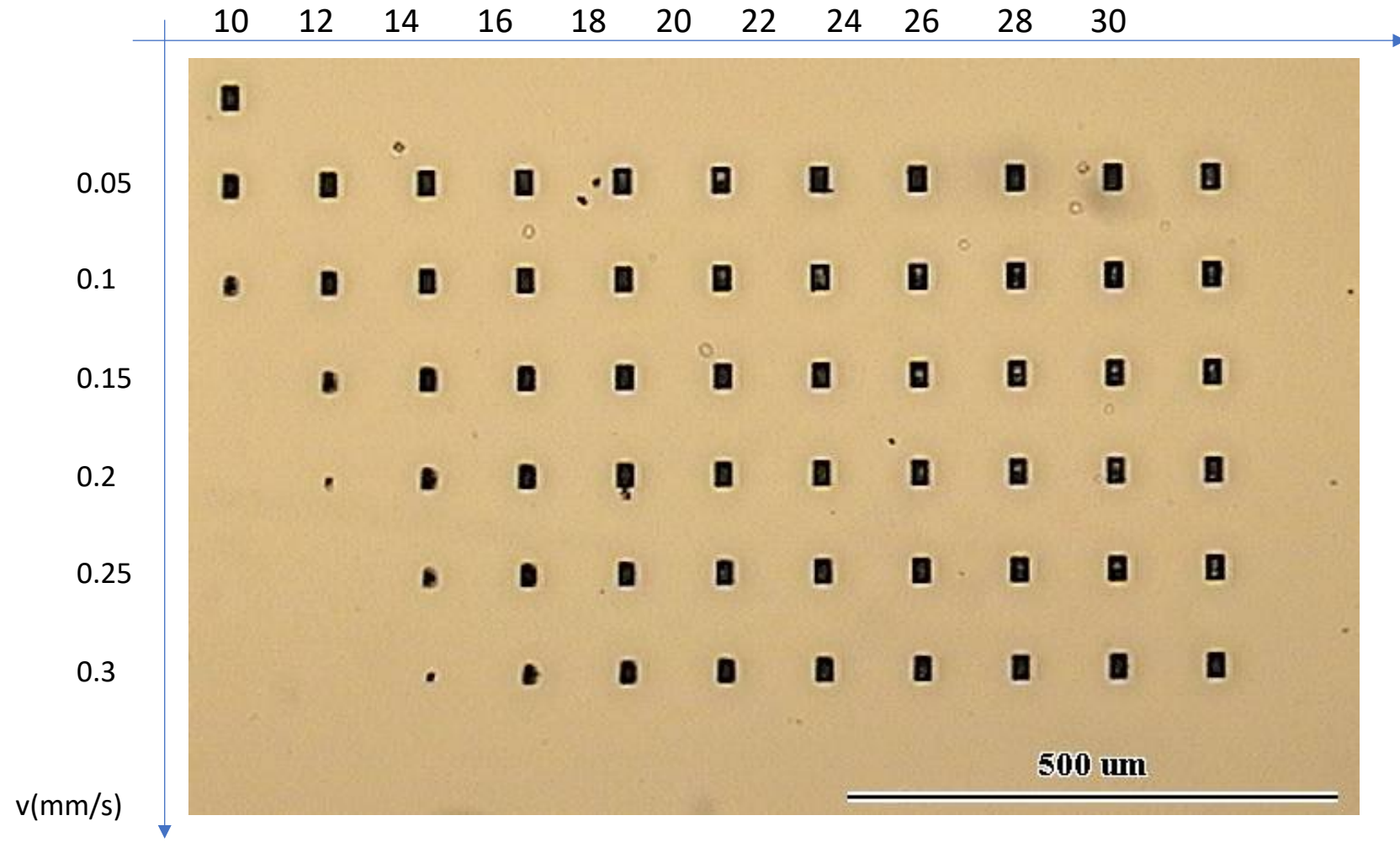
PECVD

Milestone N. 2. Repeatable process for polymeric master fabrication

**Attività 2022 INFN-BOLOGNA
(CNR IMM-Bologna e PoliTO - Chi-Lab)**

TPP test pattern: a matrix with many woodpile structures (5 μm)
ORMOCOMP / glass

AIM: determine the best printing parameters by varying laser power and velocity



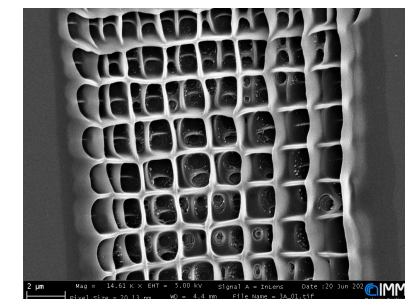
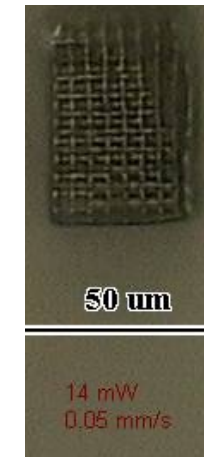
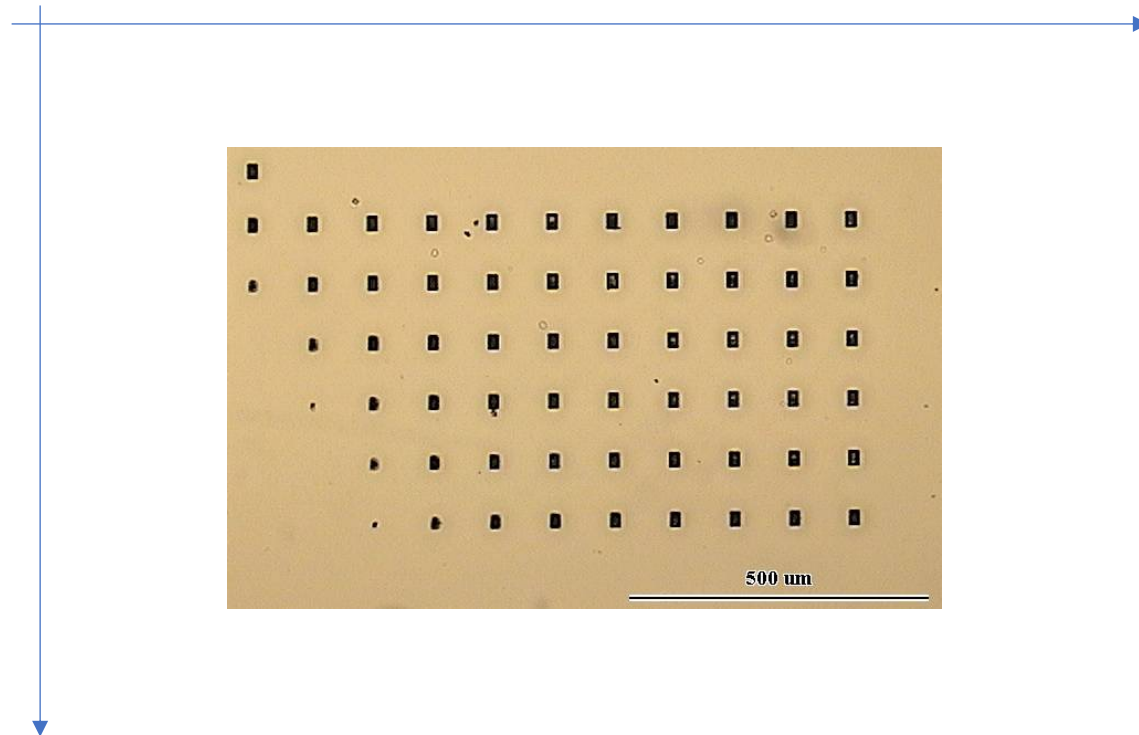
Milestone N. 2. Repeatable process for polymeric master fabrication

Test of adhesion and quality of the 3D printed structures

- Pyrolysis (graphitization) of the polymer @ 450°C and @ 690°C in Ar
- SEM observation to see **adhesion, quality of the 3D printing** and to find the best printing parameters

Good adhesion of the printed structure
to the substrate

- **Printing to be optimized**
- Results are promising,
- **Best parameters (14mW, 0,05 mm/s)**



Milestone N. 2. Repeatable process for polymeric master fabrication

**Attività 2022 INFN-BOLOGNA
(CNR IMM-Bologna e PoliTO - Chi-Lab)**

On going:

- Deposition of a-Si-H by PECVD and thermal CVD on the graphitized woodpile structures to test the % of coverage of the printed structures on the whole volume of the woodpile
- TPP fabrication of new woodpile structures on fused silica with optimized TPP optical setup

Towards 2023

- Optimization of Si deposition
- Etching tests of the skeleton after Si deposition

Towards 2024:

- SEM characterization of the morphology and geometrical quality of the woodpile structure

○ **3. Manufacturability test**
(tol < +/- 3 μ m, Ra < +/- 50 nm)



3.1 Fabbricazione Campioni
(quotazione OK, consegna prevista)

3.2 Misure metrologiche/test
campioni (fine anno)

3.3 Misure Temperatura vs
weling/brazing,
e feedback al modeling (fine anno ?)

- Metallic Samples have been commissioned to COMEB
- Manufacturing on ONGOING

MILESTONES 2023 (2nd year)



DIELECTRIC	
METALS	

- **M2** Selection of one or more dielectric EM structure
- **M3** Import EM field from HFSS to ASTRA

- **M3** Evaluation of the Beam dynamics pars
- **M4** Prototype Mechanical Draw
- **D2** Ka-band Metallic Prototype

MILESTONE 2nd year 2023



Struttura del progetto

Month		1	3	6	9	12	15	18	21	24	27	30	33	36	
WP1	T1.1					D1	M2								EM Design of optical low- and high- β dielectric structures
	T1.2					M1	D1								RF design of metallic Ka and W-band cells and mode launcher
WP2	T2.1						M3					D2			Beam dynamics in dielectric structures (ASTRA)
	T2.2						M3								Beam dynamics (GPT) and wakefield in metallic structures (CST, ASTRA)
WP3	T3.1					M1									Dielectric Manufacturability
	T3.2										M4			D3	Dielectric Fabrication and morphological characterization
WP4	T4.1					M2		M4		D2					Welding/Fabricability, Fabrication, Optimization
	T4.2									M5			D3		RF cold test of metallic prototype
WPO	T0														Networking, Management, Dissemination

Milestone primo anno (2022)

Milestone secondo anno (2023)

M1	Repeatable process and post-process steps for polymeric master fabrication
M2	selection of one (or more) EM structure
M3	import EM field from HFSS to ASTRA
M4	inversion of the master with oxide deposition/fabrication of masters for 3D printing
D1	preliminary report of the EM design
D2	full-wave model (EM+BD)
D3	Report of the dielectric study
M1	Evaluation of the RF Figure of merits on the optimized numerical model
M2	Manufacturability (tolerance, roughness) Test, welding, material handling
M3	Evaluation of the BD parameters (wakefield effects on the optimized numerical model)
M4	Mechanical engineering and executive drawing
M5	Check/Procurements of RF components/system for the measurements
D1	full-wave model (EM+BD)
D2	Ka-band metallic prototype
D3	Report of the RF characterization on the metallic prototype

Richieste finanziarie per l'anno 2023

STRUTTURA	MISSIONI [k€]	CONSUMO [ek]
BO	4 k€*	2 k€ - Fotopolimeri tipo ORMOCOMP ed SU8 per stampa 3D TPP - Wafer fused silica per realizzazione di strutture con stampa 3D TPP; - Gas di processo per deposizione di silicio mediante CVD.3k€ Missioni
LNF	4 k€ (including visit to SLAC)	21 k€ (prototipo 16 Acc. cells in «open»-technology @36 GHz+ mode Launcher)
LNS	4.6 k€ (misure @LNF e Bo)*	
MI	3 k€	
RM1	4 k€ (including visit to UCLA)	7 k€ (leghe CU/Ag)

TALK, CONF., PUBL.

- **White paper** successfully submitted to **Snowmass AF6 (Advanced Accelerator Concepts): “Laser-Driven Structure Based Accelerators”**, J. England, D. Filippetto, G. Torrissi, A. Bacci, G. Della Valle, D. Mascali, G. S. Mauro, G. Sorbello, P. Musumeci, J. Scheuer, B. Cowan, L. Schachter, Y-C. Huang, U. Niedermayer, W. D. Kimura, R. Li, R. Ishebeck, E. I. Simakov, P. Hommelhoff, R. L. Byer, arXiv:2203.08981 <https://arxiv.org/abs/2203.08981>
- Mauro, G.S.; Torrissi, G.; Locatelli, A.; Bacci, A.; De Angelis, C.; Mascali, D.; Sorbello, G. Numerical Simulation of a Hollow-Core Woodpile-Based Mode Launcher for Dielectric Laser Accelerators. *Appl. Sci.* 2022, 12, 2609. <https://doi.org/10.3390/app12052609>
- **Book Project “High Resolution Manufacturing From 2D To 3D/4D Printing: Applications in Engineering and Medicine” Photonic applications Part II - Impact on “Dielectric laser accelerators” and other case studies**, C. De Angelis, Andrea Locatelli, Giorgio S. Mauro, R. Rizzoli, G. Sorbello and G. Torrissi, submitted for publication
- **Talk** Copropagating schemes for high gradient Dielectric Laser Accelerators (DLAs) @The 3rd International Workshop on “Ultrafast Beams and Applications” 4-8 July 2022 at CANDLE Institute in Armenia, UBA22 Workshop, Yerevan, Armenia
- **Poster@** International Workshop on Breakdown Science and High Gradient Technology (HG2022) 16–19 May 2022 “COPROPAGATING SCHEMES FOR DIELECTRIC LASER ACCELERATORS (DLAS)” G. Torrissi, D. Mascali, G. S. Mauro, A. F., M. M. Costanza (DIEEI, Catania), A. Bacci, G. Sorbello, C. De Angelis, A. Locatelli
- **Poster@** HIGH GRADIENT 2022 workshop, L. Faillace, B. Spataro, M. Behtouei, M. Carillo, V. Dolgashev, G. Mauro, M. Migliorati, G. Torrissi, “Design and Prototyping of high gradient Ka-band accelerating structures, poster at HIGH GRADIENT 2022 workshop.”
- **Poster@** IPAC’22, B. Mostafa et al, Studies of a Ka-Band High Power Klystron Amplifier at INFN-LNF, Proceedings of IPAC'22, Bangkok, Thailand.
- “Copropagating schemes for high gradient Dielectric Laser Accelerators (DLAs)” submitted to SIF, 108° Congresso Nazionale 12 -16 settembre 2022, Milano
- G. Torrissi, G. Mauro, G. Sorbello, A. Usmani, C. De Angelis, A. Locatelli and A. Bacci, “Copropagating Schemes for Dielectric Laser Accelerators (DLAs)” XIV Riunione Nazionale di Elettromagnetismo Catania, 18-21 settembre 2022
- **“deposited patent n. 102021000021158 “Metodo per progettare una struttura accelerante dielettrica che supporta un modo TE210-like perturbato”** G. S. Mauro, D. Mascali G. Torrissi, S. Gammino, INFN, G. Sorbello UniCT, G. Della Valle, PoliMI
- Master degree **Thesis**, M. M. Costanza 31/03/2022, UniCT, DIEEI, CDL Ing. Delle Telecomunicazioni
- ERASMUS Master degree **Thesis**, A. Usmani, UniCT, DIEEI, CDL Ing. Delle Telecomunicazioni
- N. 2 **lessons** on DLA and RFQ @ Corso Fisica degli Acceleratori (Dr. David Mascali) anno Accademico 2022-2023
- Seminario B. Spataro, “Development of X-band and Ka band high gradient structures”, 9/5/2022
- N. 2 lessons on “Beam Dynamics”, A. Bacci, 28/4/2022 e 11/5/2022